

S/N: 09/832,884



7/18/2003

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amr

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Steve M. Danziger, et al.

Serial No.: 09/832,884

Art Unit: 2829

Divisional of 09/321,565

Filed: April 12, 2001

Examiner: Evan T. Pert

For: Method and Apparatus for Evaluating a Known Good Die Using  
Both Wire Bond and Flip-Chip Interconnects

AMENDMENT

US Patent & Trademark Office  
2011 South Clark Place  
Customer Window, Mail Stop: AF  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, VA 22202

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JUL 29 2003  
TECHNOLOGY CENTER 2800

Sir:

This Amendment is responsive to the Advisory Action dated July  
3, 2003. Claims 1 - 8 are pending and have been rejected.